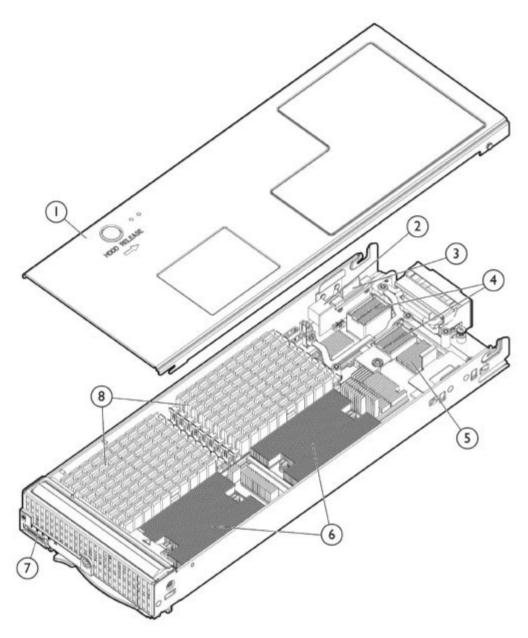
Overview



HP ProLiant BL490c G7 Server Blade

- 1. Access Panel
- 2. Internal USB connector
- 3. Internal SD card slot
- 4. Two (2) mezzanine I/O expansion slots

- Embedded Dual Port FlexFabric 10GbE Converged Network Adapter
- 6. Up to two (2) Intel® Xeon® 5600 or 5500 series processors

NOTE: SSD Drives placed on baffle above processors; See storage illustration for more details.

- 7. Local I/O connector
- 8. Eighteen (18) DDR3 DIMM Memory Slots

What's New

Support for HP BLc NC360m NIC Adapter Opt Kit



Overview

At A Glance

The HP ProLiant BL490c G7 Virtualization Blade raises the bar for memory capacity and I/O bandwidth in a half-height blade. Coupling up to 2 Intel® Xeon® processors with 18 DIMM slots and support for up to 24 NICs, the BL490c G7 gives enterprise data center managers the ideal server platform for hosting virtual machines.

This document covers the HP ProLiant BL490c G7 server blade only. For more information on HP BladeSystems c-Class Enclosure and HP BladeSystem c-Class Interconnect and Mezzanine Components, please see the following:

HP BladeSystem c-Class Enclosures QuickSpecs:

HP BladeSystem c3000 Enclosure QuickSpecs:

http://h18000.www1.hp.com/products/guickspecs/12790 div/12790 div.html

HP BladeSystem c7000 Enclosure QuickSpecs:

http://h18000.www1.hp.com/products/quickspecs/12810_div/12810_div.html

HP BladeSystem c-Class Interconnect and Mezzanine Components:

http://h18004.www1.hp.com/products/blades/components/c-class-interconnects.html http://h18004.www1.hp.com/products/blades/components/c-class-adapters.html

The HP ProLiant BL490c G7 is a 2-processor server blade optimized for virtualization with high memory capacity and high bandwidth and flexible networking.

HP ProLiant BL490c G7 server blade includes:

• Processor:

- O Up to two (2) Intel® Xeon® 5600 Series processors
- O Intel® 5520 Chipset

Memory

- O Eighteen (18) DIMM slots
- Up to 384GB, using PC3-10600R DDR3 Registered (RDIMM) memory, operating at 800MHz when fully populated at 2 DIMMs per Channel in 12 of the 18 slots
- Up to 48GB, using PC3-10600E DDR3 Unbuffered (UDIMM) memory, operating at 1066MHz when fully populated at 2 DIMMs per Channel in 12of the18 slots

• Storage Controller:

O HP Embedded SATA RAID Controller

NOTE: This is a chipset SATA RAID controller. It supports RAID 0 and 1 only and no Battery Backed Write Cache. User needs to enable the RAID option through HP RBSU (ROM Base Setup Utility) first before the RAID can be activated. Users also need to download the OS driver from: http://www.hp.com/support/BL490cG7 for OS Array Monitoring.

NOTE: HW RAID functionality requires the use of an optional Smart Array mezzanine card. See the Storage Controller options section below.

• Internal Drive Support:

- O Up to two (2) non-hot plug SATA Solid State Drives (SSD)
- With an attached D2200sbStorage Blade, up to six (12) hot plug SFF Serial Attached SCSI (SAS) or SATA Hard Drives (optional)

Network Controller:

 Integrated NC553i Dual Port FlexFabric 10GbE Adapter supporting stateless TCP/IP offload, TCP Offload Engine (TOE), Fibre Channel over Ethernet (FCoE) and iSCSI protocols

NOTE: Fibre Channel over Ethernet (FCoE) capability requires the use of an HP Virtual Connect FlexFabric 10Gb/24-port Module. Learn more at: www.hp.com/go/virtualconnect.

NOTE: Each port is autosensing 1 Gb / 10 Gb, and can interoperate with 1 Gb HP BladeSystem c-Class interconnect components. Both ports will operate at the same speed.

One (1) additional 10/100 server adapter dedicated to iLO 3 Management

• Mezzanine Support:

- O Two (2) I/O expansion mezzanine slots
- O Supports up to two (2) mezzanine cards
 - Dual Port FlexFabric Adapter mezzanine option



Overview

- Dual-Port Fibre Channel Mezzanine options for SAN connectivity (Choice of Emulex ,QLogic or Brocade)
- iSCSI Ethernet mezzanine option for optimized iSCSI connectivity
- Ethernet server adapter mezzanine options for additional network ports
- InfiniBand (IB) Mezzanine options for low latency and high bandwidth server interconnectivity
- Storage Controller mezzanine options for additional internal and external storage connectivity
- I/O Accelerator mezzanine options for high transaction rate local storage
 - SAS mezzanine option for external direct attach and shared SAS storage

Internal ŪSB Support:

- One (1) internal USB 2.0 connector for security key devices and USB drive keys
- O One (1) internal SD-HC Card slot

• Trusted Platform Module:

O One (1) internal TPM 1.2 module connector

Form Factor:

 HP ProLiant BL490c G7 is a half-height server blade that plugs into the HP BladeSystem c3000 and c7000 enclosures

• Infrastructure Management:

- O This server blade requires the latest version of the Onboard Administrator firmware. This firmware release may also require other subsystem firmware upgrades. For information on the latest firmware versions, please see the Blades Firmware Maintenance website at: http://h18004.www1.hp.com/products/blades/components/cclass-compmatrix.html
- O HP Integrated Lights-Out 3 (iLO 3) management processor for simplified server setup, health monitoring and recovery, power and thermal control, and lights-out remote administration.
- O HP Insight Control, a product option, delivers essential infrastructure management that can help save time and money by making it easy to deploy, migrate, monitor, control and optimize your IT infrastructure through a single, simple management console. Insight Control supports both Windows and Linux-based central management servers.
- O HP Matrix Operating Environment, a product option, is an integrated command center that enables IT Staff personnel to continuously analyze and optimize a converged infrastructure, while automating and reducing the cost of common data center tasks by as much as 40 percent. This ultimately enables them to dynamically keep pace with the organization's changing business requirements

Operating Systems:

Supports Windows, RHEL, SLES, Solaris, VMware, and Citrix XenServer
 NOTE: For more information on HP's Certified and Supported ProLiant Servers for OS and Virtualization
 Software and latest listing of software drivers available for your server, please visit our Support Matrix at:
 http://www.hp.com/go/ossupport

• Enclosures:

- O HP offers two different c-Class server blade enclosures to meet your individual needs:
 - The HP BladeSystem c7000 rack enclosure is 10U high and holds up to 16 ProLiant BL490c G7 servers plugged vertically.
 - The HP BladeSystem c3000 rack enclosure is 6U high and holds up to 8 HP ProLiant BL490c G7 servers plugged horizontally.
- O Server blades, storage blades, interconnect modules, power supplies, fans, and redundant Onboard Administrator modules are all designed to fit into the c3000 and c7000 enclosures
- Administrator modules are all designed to fit into the c3000 and c7000 enclosures.

 O For additional enclosure information, please see:

 http://h18004.www1.hp.com/products/blades/components/enclosures/c-class/index.html.

NOTE: For optimal cooling and system performance the BL490c G7 requires the c7000 enclosure to be configured with 10 fans and the c3000 enclosure to be configured with 6 fans.

Warranty:

O This product is covered by a global limited warranty and supported by HP Services and a worldwide network of HP Authorized Channel Partners. Hardware diagnostic support and repair is available for three years from date of purchase. Support for software and initial setup is available for 90 days from date of purchase. Enhancements to warranty services are available through HP Care Pack services or customized service agreements. Certain restrictions and exclusions apply. Hard drives have either a one year or three year warranty; refer to specific hard drive QuickSpecs for details.

NOTE: Server warranty includes 3 year Parts, 3 year Labor, 3-year on-site support. Warranty repairs may be accomplished through the use of Customer Self Repair (CSR) parts. These parts fall into two categories: 1) Mandatory CSR parts are designed for easy replacement. A travel and labor charge will result when customers decline to replace a Mandatory CSR part; 2) Optional CSR parts are also designed for easy replacement but



HP ProLiant BL490c Generation 7 (G7) Server Blade

QuickSpecs

Overview

may involve added complexity. Customers may choose to have HP replace Optional CSR parts at no charge. Additional information regarding worldwide limited warranty and technical support is available at: http://h18004.www1.hp.com/products/servers/platforms/warranty/index.html



Standard Features

NOTE: For the Standard Features shipped in the "Factory Integrated Models", please see the "Configuration Information - Factory Integrated Models" section.

Processor

One of the following depending on Model

Six Core Processors

Intel® Xeon® X5675 (3.06GHz/6-core/12MB/95W, DDR3-1333, HT, Turbo 2/2/2/2/3/3) Processor Intel® Xeon® X5670 (2.93GHz/6-core/12MB/95W, DDR3-1333, HT, Turbo 2/2/2/2/3/3) Processor Intel® Xeon® X5650 (2.66GHz/6-core/12MB/95W, DDR3-1333, HT, Turbo 2/2/2/2/3/3) Processor Intel® Xeon® E5649 (2.53GHz/6-core/12MB/80W, DDR3-1333, HT, Turbo 1/1/1/1/2/2) Processor Intel® Xeon® L5640 (2.26GHz/6-core/12MB/60W, DDR3-1333, HT, Turbo 2/2/3/3/4/4) Processor

Four Core Processors

Intel® Xeon® X5672 (3.20GHz/4-core/12MB/95W, DDR3-1333, HT, Turbo 2/2/3/3) Processor Intel® Xeon® L5630 (2.13GHz/4-core/12MB/40W, DDR3-1066, HT, Turbo 1/1/2/2) Processor

NOTE: HT indicates that the processor model supports Intel® Hyper-Threading Technology. **NOTE:** Turbo indicates the maximum potential frequency increment when using Intel® Turbo Boost Technology, with 4, 3, 2, and 1 cores active on four core 5600 series processors or with 6,5,4,3,2,1 cores active on six core 5600 series processors.

NOTE: DDR3 speed is the maximum memory speed of the processor. Actual memory speed may depend on the quantity and type of DIMMs installed.

NOTE: For the Intel 5600 Series, the letter preceding the model number indicates the performance/wattage of the processor. "X" denotes High Performance/Wattage; "E" denotes Enterprise Performance/Wattage (Mainstream): and "L" denotes Lower Wattage.

Upgradeability	Upgradeable to two (2) processors
Cache Memory	12MB shared L3 cache
Chipset	Intel® 5520 Chipset

Memory Type DDR3 Registered (RDIMM) or Unbuffered (UDIMM)

Standard 6 GB (3 x 2GB) RDIMM and 12GB (3 x 4GB) RDIMM

Maximum (RDIMM) 384 GB (12 x 32 GB) for Registered Memory configurations

Maximum (UDIMM) 48 GB (12 x 4 GB) for Unbuffered Memory configurations

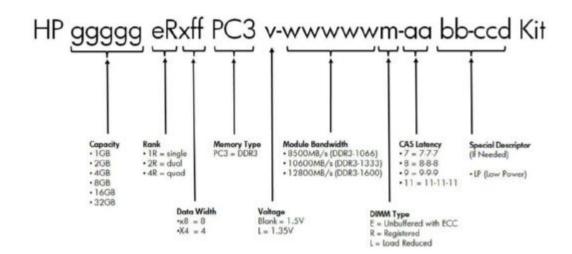
NOTE: A minimum of 2GB of memory must be installed.

NOTE: Depending on the memory configuration and processor model the memory speed may run at 1333MHz, 1066MHz or 800MHz. Please see the Online Memory Configuration Tool for details; www.hp.com/go/ddr3memory-configurator

DDR3 memory options part number decoder



Standard Features



Memory Protection

Advanced ECC (multi-bit error protection)

Memory Mirroring Mode Memory Lock-Step Mode

Memory Online Spare Mode supported on Xeon 5600 Series processors

Network Controller

Integrated NC553i Dual Port FlexFabric 10Gb Adapter

NOTE: FlexFabric capability requires the use of an HP Virtual Connect Flex-Fabric module. Learn

more at: www.hp.com/go/virtualconnect.

NOTE: Fibre Channel over Ethernet (FCoE) capability requires the use of an HP Virtual Connect

FlexFabric 10Gb/24-port Module. Learn more at: www.hp.com/go/virtualconnect.

One (1) additional 10/100 NIC dedicated to iLO 3 Management

I/O Expansion Slots

Two (2) I/O expansion mezzanine slots (x8 PCI Express)

Integrated Manageability HP Integrated Lights-Out 3 (iLO 3) management processor

Storage Controller

HP Embedded SATA RAID Controller

NOTE: This is a chipset SATA RAID controller. It supports RAID 0 and 1 only and no Battery Backed Write Cache. User needs to enable the RAID option through HP RBSU (ROM Base Setup Utility) first before the RAID can be activated. Users also need to download the OS driver from: http://www.hp.com/support/BL490cG7 for OS Array Monitoring.

NOTE: HW RAID functionality requires the use of an optional Smart Array mezzanine card. See the Storage Controller options section below.

Maximum Internal Storage

Non-Hot Plug SATA

800GB

2 x 400GB

One of the following depending on Model

NOTE: Hot Plug SFF SAS maximum internal storage supported with optional D2200sb Storage

Blade attached.

SSD



Standard Features

Graphics

Integrated Matrox G200

Resolution Color Depths 1600 x 1200, 64K, 256, 16

1280 x 1024, 16.7M, 64k, 256, 16 1024 x 768, 16.7M, 64k, 256, 16 800 x 600, 16.7M, 64k, 256, 16 640 x 480, 16.7M, 64k, 256, 16

NOTE: Maximum resolution available via HP Integrated Lights-Out 3 (iLO 3) remote console is 1280 x 1024.

Fibre Channel Support Two (2) optional Fibre Channel HBAs are supported by the HP ProLiant BL490c G7. Both mezzanine circuit boards connect directly to the server blade system board. These Fibre Channel HBAs are available via option kits and must be ordered separately.

HBA mezzanine card option kits:

Emulex LPe1105 4Gb Fibre Channel Host Bus Adapter for c-Class BladeSystem (PN 403621-B21)

 Based on the same field-proven ASIC, firmware, and driver technology as Emulex's renowned LPe1150 HBA, the Emulex LPe1105-HP is fully driver compatible with all Emulex **HBAs**

Emulex LPe1205 8Gb Fibre Channel Host Bus Adapter for c-Class BladeSystem (PN 456972-

 Exceptional performance, enhanced security, and scalable management for virtual server and enterprise-class applications

QLogic QMH2462 4Gb Fibre Channel Host Bus Adapter for c-Class BladeSystem (PN 403619-B21)

 Uses common drivers which means that customers can standardize on one QLogic driver whether they are using the QMH2462 or other HBAs powered by QLogic

QLogic QMH2562 8Gb Fibre Channel Host Bus Adapter for c-Class BladeSystem (PN 451871-B21)

 Provides a first step into the 8Gb future, advanced, embedded support for virtualized environments and reduced power consumption

HP BLc Brocade 804 8Gb Fibre Channel Host Bus Adapter (PN 590647-B21)

 Application oriented Quality of Service (AQoS) providing the ability to configure, prioritize, and optimize traffic flows from virtual machines and/or applications to the target port

Brocade, Emulex and QLogic Fibre Channel HBAs for HP BladeSystem c-Class feature:

- Optimal performance utilizing PCI Express
- 4/2/1Gb/s auto negotiating speeds (4Gb HBAs)
- 8/4/2Gb/s auto negotiation speeds (8Gb HBAs)
- Dual-ports for redundant path connections
- Up to two FC HBAs per server blade providing redundant FC HBA support
- Optimized for HP Storage and supported by third party SAN vendors
- Support for Microsoft® Windows® and Linux operating system environments



Standard Features

Compatible SAN

HP ProLiant BL490c G7 server blades are optimized for HP MSA, EVA and XP

HP ProLiant BL490c G7 server blades are compatible with select 3rd party SANs (please see blade storage page for more details: http://h18004.www1.hp.com/products/blades/components/c-class-sans.html

HP Virtual Connect

HP Virtual Connect is an interconnect option for BladeSystem c-Class that simplifies server connectivity to data and storage networks, and reduces costs. Unique HP Flex-10 and FlexFabric technologies make maximum use of network bandwidths, provide dynamic tuning and enable extreme flexibility to meet individual server and infrastructure requirements. HP Virtual Connect Enterprise Manager (VCEM) provides a central console to administer network connections and workloads for thousands of servers. For more information on Virtual Connect Ethernet, Fibre Channel, Converged Network and management options see: www.hp.com/go/virtualconnect

HP Insight HP Service Pack for management software ProLiant

HP Service Pack for ProLiant (SPP) and HP Smart Update Manager (HP SUM) version 5 provide a new, comprehensive approach to firmware and system software maintenance. Together they provide better operating stability and ensure maximum uptime. The SPP will be updated at a predictable cadence, typically coinciding with new HP server hardware launches. By enabling firmware to be updated online and integrating firmware and system software updates in one operation HP SUM and the SPP offer faster updates of individual servers and dramatically faster updates of entire BladeSystem enclosures. Further improving system uptime and stability is the fact that HP provides 12 months of support on each Service Pack for ProLiant.

The user experience around HP SUM and the SPP has been improved in several ways, starting with the web download. A single web page provides access to a single download containing both the latest version of HP SUM version 5 and the latest SPP. Optional smaller subsets with only specific types of servers or specific operating systems are offered to save on download time. The HP SUM application has been re-written to provide a more straightforward, intuitive user interface that guides the user through the steps of discovery, analyses and update, providing comprehensive information on available updates, criticality and interdependencies. This information is also available in reports. By providing the option of multiple local or shared repositories which can be easily updated from hp.com, HP SUM provides the tools to optimize stability and consistency throughout the company. While HP SUM and the SPP will recommend the combinations of firmware and system software that HP has found to be the best practice, the application gives customers the flexibility to set their own specific baseline.

The Service Pack for ProLiant has been rigorously tested with specific attention for interaction between firmware, drivers and agents both within the server as well as in interaction with the BladeSystem enclosure components (Onboard Administrator and Virtual Connect). This testing ensures the highest quality as well as providing the input for HP SUM to deploy updates taking into account all interdepencies, when determining the correct updates and order of update deployment.

The Service Pack for ProLiant (which includes HP SUM 5) can be downloaded from www.hp.com/go/spp/download. More information can be found: www.hp.com/go/spp and http://www.hp.com/go/hpsum

HP Insight Foundation

Insight Foundation is being baselined at version v8.70 which means the



Standard Features

following:

- Its Media Kit (contains 2 SmartStart CDs, the Firmware DVD, and the Management DVD) will continue to ship with all supported ProLiant G7 or earlier BTO servers until the last supported server is no longer shipping.
- The Media Kit will not be updated past version 8.70.
- ProLiant G7 or earlier CTO servers are able to order the Media Kit with the understanding that the media is not updated. Please check specific server QuickSpecs for availability of CTO Kit.
- PSP and Firmware DVD downloads will be updated through 2Q 2012 at the HP Insight Foundation Suite for ProLiant downloads tab: http://www.hp.com/go/foundation

Customers are urged to use the replacement product, HP Service Pack for ProLiant, instead of Insight Foundation Suite which is found at these location:

- www.hp.com/go/spp
- www.hp.com/go/spp/download

HP Integrated Lights-Out HP Integrated Lights-Out (iLO) simplifies server setup, health monitoring, power and thermal control, and lights-out remote administration of ProLiant ML, DL, and BL servers. HP iLO functions without additional software and can be accessed from any location via a web browser. HP iLO works hand-in-hand with HP Systems Insight Manager, Insight Control suites, and HP Matrix Operating Environment, helping customers unleash the value of the ProLiant platform and deliver the highest possible quality of IT service. For more information, visit: www.hp.com/go/iLO

HP Insight Control

HP Insight Control, a product option, delivers essential infrastructure management that can help save time and money by making it easy to deploy, migrate, monitor, remote control, and optimize your IT infrastructure through a single, simple management console.

Two versions of Insight Control are available, to serve environments requiring either a Linux-based or a Windows-based central management server: HP Insight Control for Linux, and HP Insight Control. See www.hp.com/go/insightcontrol

HP Insight Control includes one year of 24 x 7 HP Software Technical Support and Update Service ensuring rapid access to HP support staff and proactive delivery of software updates. For more information about this service, please visit: http://www.hp.com/services/insight.

HP Matrix Operating Environment

The HP Matrix Operating Environment (Matrix OE) for ProLiant and Integrity servers is an integrated command center that helps you instantly adjust to dynamic business demands. This advanced infrastructure management software lets you reduce the cost of common data center tasks by up to 40 percent while keeping pace with your changing business.

The HP Matrix OE includes the automated provisioning, optimization, and recovery management capabilities for HP CloudSystem Matrix, the ideal platform for private cloud and Infrastructure as a Service (laaS).

NOTE: For more information, visit: http://www.hp.com/go/matrixoe



HP ProLiant BL490c Generation 7 (G7) Server Blade

Standard Features

High Performance Clusters

HP Cluster Platforms

HP Cluster Platforms are specifically engineered, factory-integrated large-scale ProLiant clusters optimized for High Performance

Computing, with a choice of servers, networks and software. Operating system options include specially priced offerings for Red Hat Enterprise Linux and SUSE Linux Enterprise Server, as well as Microsoft Windows

 $\label{lem:hpc} \mbox{HPC Server. A Cluster Platform Configurator simplifies ordering.}$

http://www.hp.com/go/clusters

HP HPC Interconnects

High Performance Computing (HPC) interconnect technologies are available for this server as part of the HP Cluster Platform portfolio. These high-speed InfiniBand and Gigabit interconnects are fully supported by HP when integrated within an HP cluster. Flexible, validated solutions can be defined with the help of configuration tools.

http://www.hp.com/techservers/clusters/ucp/index.html

HP Insight Cluster Management Utility HP Insight Cluster Management Utility (CMU) is an HP-licensed and HP-supported suite of tools that are used for lifecycle management of hyperscale clusters of Linux ProLiant systems. CMU includes software for the centralized provisioning, management and monitoring of nodes. CMU makes the administration of clusters user friendly, efficient, and effective. http://www.hp.com/go/cmu

HP HPC Linux Value Pack

HP HPC Linux Value Pack (Value Pack) is an HP-licensed and HP-supported option to HP Insight CMU, for the development and deployment of applications on HPC Cluster Platforms. Value Pack includes the Platform LSF workload scheduler and Platform Application Center, as well as the HP-MPI parallelization library. HP HPC Linux

Value Pack

Operating Systems and Microsoft Windows Server

Virtualization Software Red Hat Enterprise Linux (RHEL)
Support for ProLiant SUSE Linux Enterprise Server (SLES)
Servers Solaris

Solaris VMware Citrix XenServer

NOTE: For more information on HP's Certified and Supported ProLiant Servers for OS and Virtualization Software and latest listing of software drivers available for your server, including how to purchase from HP, please visit our OS Support at: http://www.hp.com/go/ossupport

Availability

Dual-port embedded 10 Gigabit adapters for redundant network connections

Two (2) non hot-plug SATA SSD with integrated chipset RAID

Redundant ROM Advanced ECC Memory

Support for Memory Mirroring Mode and Memory Lock-Step Mode

Support for Memory Online Spare Mode with Xeon 5600 Series processors

Network adapter teaming (network fault tolerance, transmit load balancing, switch-assisted load

balancing)

Industry Standard Compliance

ACPI V2.0 Compliant PCI 2.2 Compliant WOL Support

Microsoft® Logo certifications

USB 2.0 Support IMPI 2.0 Compliant SMASH CLP Compliant



Standard Features

Security

- Power-on password
- Administrator's password
 - Integrated Lights-Out 3 with:
 - o 12 customizable user accounts
 - o SSL encryption
 - O Secure Shell version 2
 - Advanced Encryption Standard (AES) and Triple Data Encryption Standard (3DES) on browser, CLP and XML scripting interface
 - O AES and RC4 encryption of video
 - O Disable via a global setting
- Keyboard password
- External USB port enable/disable
- Network server mode
- Serial interface control
- TPM (Trusted Platform Module) 1.2 option

Factory Express Portfolio for Servers and Storage

HP Factory Express offers configuration, customization, integration and deployment services for HP servers and storage products. Customers can choose how their factory solutions are built, tested, integrated, shipped and deployed.

Factory Express offers service packages for simple configuration, racking, installation, complex configuration and design services as well as individual factory services, such as image loading, asset tagging, and custom packaging. HP products supported through Factory Express include a wide array of servers and storage: HP Integrity, HP ProLiant, HP ProLiant Server Blades, HP BladeSystem, HP 9000 servers as well as the MSAxxxx, VA7xxx, EVA, XP, rackable tape libraries and configurable network switches.

For more information on Factory Express services on your specific server model please contact your sales representative or go to: http://www.hp.com/go/factory-express.

HP Simple Configurator

SCE is a guided self service tool to help sales and non technical people provide customers with initial configurations in 3 to 5 minutes. You may then send the configuration on for configuration help, or use in your existing ordering processes. If you require "custom" rack configuration or configuration for products not available in SCE, please contact HP's Customer Business Center or an Authorized Partner for assistance. http://www.hp.com/products/configurator



Service and Support

Service and Support

HP Technology Services for Industry Standard Servers and BladeSystem

Capitalizing on HP ProLiant server and HP BladeSystem capabilities requires a service partner who understands your increasingly complex business technology environment. That's why it makes sense to team up with the people who know HP infrastructure hardware and software best - the experienced professionals at HP Services.

What HP ProLiant and BladeSystem Services can do for you

HP ProLiant and BladeSystem Services can help you design, deploy, test, integrate, support, and manage IT and infrastructure solutions. This way, HP proposes services solutions that include more than just uplift of base warranty. You can get the support you need by choosing from one of a number of service packaged solutions we have designed to address wider set of customer support needs.

HP Technology Services meets business challenges with services offered in three packages - Optimized Care Package, Standard Care Package, and Basic Care Package - available for each product group. Such packaged solutions enable customers to optimize technology operations, minimize risk and drive better business outcomes with easy-to-buy, easy-to-use scalable support packages for servers, storage, networking and software.

Optimized Care Package

Supports maintaining servers at optimum performance availability

HP Installation and Startup Service for HP BladeSystem c-Class Infrastructure for c3000/c7000 enclosure

Provides for the installation and startup of a BladeSystem c3000 Infrastructure in a single blade enclosure including hardware and software, including deployment of OS, HP SIM, RDP, RDP, PMP and VPM

http://h20195.www2.hp.com/V2/GetPDF.aspx/4AA0-5964ENW.pdf

3-Year HP Critical Advantage L3 for c3000/c7000 enclosure + 3-Year HP Critical Advantage L3 for Blade server

Provides end-to-end infrastructure support solution for business critical applications running on virtualized/x86 infrastructures, enabling the customers to cost effectively build, operate, and continuously improve their IT environment

http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=4AA3-1772ENW.pdf

HP Installation and Startup Service for HP BladeSystem c-Class Enhanced Network HP Provides for the configuration and testing of BladeSystem Ethernet interconnect switches to facilitate proper implementation of network protocols and access to advanced features. http://h20195.www2.hp.com/V2/GetPDF.aspx/4aa0-5969ENW.pdf

Additional Services: Virtualization Services - Strategy, Design, Transition, Operation, Continual Service Improvement.



Service and Support

Standard Care PackagePackage that maintains high level of server availability

HP Installation and Startup Service for HP BladeSystem c-Class Infrastructure for c3000/c7000 enclosure

Provides for the installation and startup of a BladeSystem c3000 Infrastructure in a single blade enclosure including hardware and software, including deployment of OS, HP SIM, RDP, RDP, PMP and VPM

http://h20195.www2.hp.com/V2/GetPDF.aspx/4AA0-5964ENW.pdf

HP Installation and Startup Service for HP BladeSystem c-Class Enhanced Network

HP Provides for the configuration and testing of BladeSystem Ethernet interconnect switches to facilitate proper implementation of network protocols and access to advanced features http://h20195.www2.hp.com/V2/GetPDF.aspx/4aa0-5969ENW.pdf

3-Year, HP 6 hour Hardware Support Onsite Call-to-Repair Service for c3000/c7000 enclosure + 3-Year, HP 6 hour Hardware Support Onsite Call-to-Repair Service for Blade server

Provides an IT manager with a team of support specialists who will quickly begin troubleshooting the system to help return the hardware to operating condition within 6 hours of the initial service request to the HP Global Solution Center

http://h20195.www2.hp.com/V2/GetPDF.aspx/5982-6547EN.pdf

3-Year, HP 24x7 Software Support for Insight Control

Provides for the deployment and basic configuration of HP Insight Control on HP ProLiant ML and DL series servers or HP BladeSystem servers

http://h20195.www2.hp.com/V2/GetPDF.aspx/5981-6645EEE.pdf

1-Year HP Proactive Select 30 Credit

Provides a flexible way to purchase HP best-in-class consultancy and technical services http://h20195.www2.hp.com/v2/GetPDF.aspx/4AA2-3842ENN.pdf

Additional Services: Software OS (Microsoft, Linux (SUSE/Red Hat) & VMware Installation & Start Up and Software Support); Microsoft or Linux or VMware education courses; +60 Proactive Select Credits, Factory Express.

Basic Care Package

Delivers minimum recommended support service level

HP Installation and Startup Service for HP BladeSystem c-Class Infrastructure for c3000/c7000 enclosure

Provides for the installation and startup of a BladeSystem c3000 Infrastructure in a single blade enclosure including hardware and software, including deployment of OS, HP SIM, RDP, RDP, PMP and VPM

http://h20195.www2.hp.com/V2/GetPDF.aspx/4AA0-5964ENW.pdf

3-Year, HP 24x7 4 hour Response, Hardware Support Onsite Service for c3000/c7000 enclosure + 3-Year, HP 24x7 4 hour Response, Hardware Support Onsite Service for Blade server

Provides you with rapid remote support and if required an HP authorized representative who will arrive on site any time and day of the year to begin hardware maintenance service within 4 hours of the service request being logged

http://h20195.www2.hp.com/V2/GetPDF.aspx/5982-6547EEE.pdf

3-Year, HP 24x7 Software Support for Insight Control

Provides for the deployment and basic configuration of HP Insight Control on HP ProLiant ML and DL series servers or HP BladeSystem servers

http://h20195.www2.hp.com/V2/GetPDF.aspx/5981-6645EEE.pdf



Service and Support

1-Year HP Proactive Select 10 Credit

Provides a flexible way to purchase HP best-in-class consultancy and technical services http://h20195.www2.hp.com/v2/GetPDF.aspx/4AA2-3842ENN.pdf

Additional Services: Startup Blade System c-Cass Enhanced Network Service; Software OS (Microsoft, Linux (SUSE/Red Hat) & VMware Installation & Start Up and Software Support); +30 Proactive Select Credits, Factory Express

Insight Remote Support

The packages include HP Insight Remote Support that uses proven technology to deliver secure, reliable 24x7 remote monitoring, diagnoses, and problem resolution. It is available at no additional cost to all warranty, HP Care Pack Service, and service agreement customers.

For more information

To learn more on HP ProLiant servers and HP BladeSystem servers, please contact your HP sales representative or HP Authorized Channel Partner. Or visit: www.hp.com/services/bladesystem



Models

Models

NOTE: Not all models are available in all regions. Check with your local country HP offices for availability.

NOTE: For the Standard Features shipped in the "Factory Integrated Models", please see the "Configuration Information -

Factory Integrated Models" section.

HP ProLiant BL490c G7 X5675 1P 12GB-R

Server 637392-B21

HP ProLiant BL490c G7 X5670 1P 12GB-R **Emb SATA Server**

HP ProLiant BL490c G7 X5650 1P 6GB-R

Emb SATA Server 603602-B21

603599-B21

HP ProLiant BL490c G7 L5630 1P 12GB-L **Emb SATA Server** 603605-B21

HP ProLiant BL490c G7 E5649 1P 6GB-R Server

637615-B21

Processor(s) One of the following

depending on Model

(1) Intel® Xeon® Processor X5675 (3.06GHz/6-core/12MB/95W, DDR3-1333, HT, Turbo 2/2/2/2/3/3)

(1) Intel ® Xeon® Processor X5670 (2.93GHz/6-core/12MB/95W, DDR3-1333, HT, Turbo 2/2/2/3/3)

(1) Intel® Xeon® Processor X5650 (2.66GHz/6-core/12MB/95W,

DDR3-1333, HT, Turbo, 2/2/2/2/3/3)

(1) Intel® Xeon® Processor L5630 (2.13GHz/4-core/12MB/40W, DDR3-

1066, HT, Turbo, 1/1/2/2)

(1) Intel® Xeon® Processor E5649 (2.53GHz/6-core/12MB/80W,

DDR3-1333, HT, Turbo1/1/1/1/2/2)

Cache Memory 12MB

Memory

One of the following

depending on Model

Network Adapter

Storage Controller Hard Drives Internal Storage Optical Drive

Power Supply Form Factor

12 GB (3 x 4 GB) PC3-10600 (DDR3-1333) Registered DIMMs

6 GB (3 x 2 GB) PC3-10600 (DDR3-1333) Registered DIMMs 12GB (3 x 4 GB) PC3L-10600 (DDR3-1333) Low Voltage Registered

Embedded NC553i Dual Port FlexFabric 10GbE Adapter and one (1)

additional 10/100 server adapter dedicated to iLO 3 Management

HP Embedded SATA chipset RAID

None ship standard

SSD: Up to 800GB (2 x 400GB) SATA, Maximum

None None

Up to eight (8) half-height blades supported in the HP BladeSystem

c3000 Enclosure

Up to sixteen (16) half-height blades supported in HP BladeSystem

c7000 Enclosure





Configuration Information - Factory Integrated Models

NOTE: This section lists some of the steps required to configure a Factory Integrated Model. To ensure only valid configurations are ordered. HP recommends the use of an HP approved configurator. Contact your local sales representative for information on CTO product offerings and requirements.

NOTE: HP does not allow factory integration of options into standard models listed above.

Configure-to-order server blades must start with a CTO Blade.

NOTE: FIO indicates that this option is a Factory Installable Option.

Step 1: Base Server Blade Configuration (Select a configurable Blade)

HP ProLiant BL490c G7 Configure-to-order Server Models

603719-B21

Configurable Model ships with:

Integrated NC553i Dual Port FlexFabric 10Gb Adapter and one (1) additional

10/100 server adapter dedicated to iLO 3 management

Integrated Lights-Out 3 Standard Blade Edition

Step 2: Choose Required Options (one of the following from each list unless

otherwise noted	A)
HP Processors	For single processor configuration choose:

NOTE: If two processors are desired, select one xxxxxx-L21 and one xxxxxx-B21.

Six-Core Processor Option Kits

HP BL490c G7 Intel® Xeon® X5675 (3.06GHz/6-core/12MB/95W) FIO Processor Kit	637437-L21
HP BL490c G7 Intel® Xeon® X5670 (2.93GHz/6-core/12MB/95W) FIO Processor Kit	603600-L21
HP BL490c G7 Intel® Xeon® X5650 (2.66GHz/6-core/12MB/95W) FIO Processor Kit	603603-L21
HP BL490c G7 Intel® Xeon® E5649 (2.53GHz/6-core/12MB/80W) FIO Processor Kit	637441-L21
HP BL490c G7 Intel® Xeon® L5640 (2.26GHz/6-core/12MB/60W) FIO Processor Kit	612892-L21

Four-Core Processor Option Kits

HP BL490c G7 Intel® Xeon® X5672 (3.20GHz/4-core/12MB/95W) FIO	637439-L21
Processor Kit	
HP BL490c G7 Intel® Xeon® L5630 (2.13GHz/4-core/12MB/40W) FIO	603606-L21
Processor Kit	

HP Memory Registered DIMMS (RDIMMs)

Memory Kit	
HP 4GB (1x4GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9	500658-B21
Memory Kit	
HP 4GB (1x4GB) Single Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9	593339-B21
Memory Kit	
HP 4GB (1x4GB) Single Rank x4 PC3L-10600 (DDR3-1333) Registered CAS-9	604504-B21

Low Power Memory Kit **NOTE:** Low Voltage DIMMs can only be used with Intel Xeon 5600 series

HP 2GB (1x2GB) Dual Rank x8 PC3-10600 (DDR3-1333) Registered CAS-9

HP 8GB (1x8GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 500662-B21

Memory Kit



500656-B21

Configuration Information - Factory Integrated Models

HP 8GB (1x8GB) Dual Rank x4 PC3L-10600 (DDR3-1333) Registered CAS-9 Low Power Memory Kit	604506-B21
NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors.	
HP 16GB (1x16GB) Dual Rank x4 PC3L-10600 (DDR3-1333) Registered CAS-9 LP Memory Kit	627812-B21
HP 16GB (1x16GB) Quad Rank x4 PC3-8500 (DDR3-1066) Registered CAS-7 Memory Kit	500666-B21
HP 32GB (1x32GB) Quad Rank x4 PC3L-8500 (DDR3-1066) Registered CAS-7 LP Memory Kit	627814-B21
Unbuffered with ECC DIMMs (UDIMMs)	
HP 1GB (1x1GB) Single Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit	500668-B21
HP 2GB (1x2GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit	500670-B21
HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit	500672-B21
NOTE: All DDR3 memory option kits consist of one DIMM per kit. For detailed memory configuration rules and guidelines, please use the Online DDR3 Memory Configuration Tool: www.hp.com/go/ddr3memory-configurator. NOTE: Kits described as LP include Low Power DIMMs. For more information on ProLiant Energy Efficient Features, see: www.hp.com/go/proliant-energy-efficient.	
NOTE: PC3L is a low voltage memory.	

Step 3: Choose Additional Options for Factory Integration

NOTE: For additional options, please refer to the "Core Options" and "Additional Options" section below. For additional options, including server blade enclosures interconnect and mezzanine options and power subsystem options; please see the Core Options and Additional Options sections below; or the following:

HP BladeSystem c-Class Enclosures QuickSpecs:

HP BladeSystem c3000 Enclosure QuickSpecs:

http://h18000.www1.hp.com/products/quickspecs/12790_div/12790_div.html

HP BladeSystem c7000 Enclosure QuickSpecs:

http://h18000.www1.hp.com/products/quickspecs/12810_div/12810_div.html

and HP BladeSystem c-Class Interconnect and Mezzanine Components:

http://h18004.www1.hp.com/products/blades/components/c-class-interconnects.html

http://h18004.www1.hp.com/products/blades/components/c-class-adapters.html



Core Options

NOTE: Some options may not be available for factory integration. Please contact an HP sales representative for additional

HP Ethernet MezzanineGigabit Ethernet Mezzanines

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HP NC325m PCI Express Quad Port Gigabit Server Adapter 416585-B21

NOTE: If the NC325m is installed in mezzanine slot 1 of a half-height server.

connectivity will be provided on 2 of the 4 ports.

HP NC360m Dual Port 1GbE BL-c Adapter 445978-B21 HP NC364m Quad Port 1GbE BL-c Adapter 447883-B21

NOTE: If the NC364m is installed in mezzanine slot 1 of a half-height server,

connectivity will be provided on only 2 of the 4 ports.

HP NC382m PCI Express Dual Port Multifunction Gigabit Server Adapter

NOTE: The Gigabit Ethernet adapters above transmit from the server at 2000 Mbps, full duplex per port only. For more information, see the "Network Controller" segment in the Standards Features section.

10 Gigabit Ethernet Mezzanines

NOTE: A 10 Gigabit Ethernet adapter is required for each server blade connecting to a 10Gb interconnect in bays 3-8 (HP BladeSystem c7000 Enclosure) or bays 2-4 (HP BladeSystem c3000 Enclosure).

NOTE: Each 10 Gigabit Ethernet adapter requires a minimum of 2GB of server

NOTE: Each 10 Gigabit Either adapter supports linking at 1000Mbps or 10000Mbps when not connected to a Flex-10 enabled module and will link with all current 1Gb switches at 1Gb.

NOTE: The ROM Based Setup Utility (RBSU) feature allows for the configuring of a FlexFabric Adapter to any of the supported protocols. For example iSCSI to FCoE (Fibre Channel over Ethernet). Note that a HP Virtual Connect profile takes precedence over the setting in this menu. Also, some FlexFabric Adapters may require that network boot be enabled in order to configure the protocol. If the protocol is configured without enabling network boot with certain FlexFabric Adapters, the protocol may not take effect. Once the protocol has taken effect on the first boot after configuring this option, network boot may be disabled if desired.

HP NC532m Dual Port 10GbE Multifunction BL-c Adapter	467799-B21
HP NC542m Dual Port Flex-10 10GbE BL-c Adapter	539857-B21
HP NC552m 10Gb 2-port Flex-10 Ethernet Adapter	610609-B21
HP NC553m 10Gb 2-port FlexFabric Adapter	613431-B21

HP Fibre Channel Mezzanine Options

Emulex LPe1205 8Gb Fibre Channel Host Bus Adapter for c-Class BladeSystem	456972-B21
Emulex LPe1105 4Gb Fibre Channel Host Bus Adapter for c-Class BladeSystem	403621-B21
QLogic QMH2562 8Gb Fibre Channel Host Bus Adapter for c-Class BladeSystem	451871-B21
QLogic QMH2462 4Gb Fibre Channel Host Bus Adapter for c-Class BladeSystem	403619-B21



HP BLc Brocade 804 8Gb Fibre Channel Host Bus Adapter

590647-B21

453246-B21

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Six-Core Processors			
HP BL490c G7 Intel® Xeon® X5670 (2.93GHz/6-core/12MB/95W) Processor Kit HP BL490c G7 Intel® Xeon® X5650 (2.65GHz/6-core/12MB/95W) Processor Kit HP BL490c G7 Intel® Xeon® E5640 (2.26GHz/6-core/12MB/95W) Processor Kit HP BL490c G7 Intel® Xeon® L5640 (2.26GHz/6-core/12MB/96W) Processor Kit HP BL490c G7 Intel® Xeon® L5640 (2.26GHz/6-core/12MB/96W) Processor Kit HP BL490c G7 Intel® Xeon® X5672 (3.20GHz/4-core/12MB/96W) Processor Kit HP BL490c G7 Intel® Xeon® L5630 (2.13GHz/4-core/12MB/96W) Processor Kit HP BL490c G7 Intel® Xeon® L5630 (2.13GHz/4-core/12MB/96W) Processor Kit NOTE: When upgrading or ordering spares for CPU 1, reuse the heatsink that was originally shipped with CPU 1 and ensure sufficient thermal grease is applied. HP Memory Registered DIMMs (RDIMMs) HP 2GB (1x2GB) Dual Rank x8 PC3-10600 (DDR3-1333) Registered CAS-9 Memory Kit HP 4GB (1x4GB) Single Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 Memory Kit HP 4GB (1x4GB) Single Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 Memory Kit HP 4GB (1x4GB) Single Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. HP 8GB (1x8GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 Low Power Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. HP 16GB (1x16GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 Low Power Memory Kit HP 8GB (1x8GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 Low Power Memory Kit HP 16GB (1x16GB) Quad Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 LP Memory Kit HP 16GB (1x16GB) Quad Rank x4 PC3-10600 (DDR3-1333) Unbuffered CAS-9 LP Memory Kit HP 16GB (1x16GB) Quad Rank x4 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 2GB (1x2GB) Dual Rank x4 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 2GB (1x2GB) Dual Rank x4 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 2GB (1x2GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333	HP Processors	Six-Core Processors	
HP BL490c G7 Intel® Xeon® X5650 (2.66GHz/6-core/12MB/95W) Processor Kit HP BL490c G7 Intel® Xeon® E649 (2.53GHz/6-core/12MB/95W) Processor Kit HP BL490c G7 Intel® Xeon® E649 (2.53GHz/6-core/12MB/96W) Processor Kit HP BL490c G7 Intel® Xeon® L5640 (2.26GHz/6-core/12MB/96W) Processor Kit Four-Core Processors HP BL490c G7 Intel® Xeon® L5630 (2.13GHz/4-core/12MB/96W) Processor Kit HP BL490c G7 Intel® Xeon® L5630 (2.13GHz/4-core/12MB/96W) Processor Kit NOTE: When upgrading or ordering spares for CPU 1, reuse the heatsink that was originally shipped with CPU 1 and ensure sufficient thermal grease is applied. HP Memory Registered DIMMs (RDIMMs) HP 2GB (1x2GB) Dual Rank x8 PC3-10600 (DDR3-1333) Registered CAS-9 Memory Kit HP 4GB (1x4GB) Single Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 Memory Kit HP 4GB (1x4GB) Single Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 Memory Kit HP 4GB (1x4GB) Single Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. HP 8GB (1x8GB) Dual Rank x4 PC3L-10600 (DDR3-1333) Registered CAS-9 Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. HP 16GB (1x1GGB) Dual Rank x4 PC3L-10600 (DDR3-1333) Registered CAS-9 Low Power Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. HP 16GB (1x1GGB) Dual Rank x4 PC3L-10600 (DDR3-1333) Registered CAS-9 Low Power Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. HP 16GB (1x1GGB) Dual Rank x4 PC3L-10600 (DDR3-1333) Registered CAS-9 LP Memory Kit HP 3CB (1x2GB) Dual Rank x4 PC3L-10600 (DDR3-1333) Registered CAS-9 LP Memory Kit HP 3CB (1x1GGB) Dual Rank x4 PC3L-10600 (DDR3-1333) Unbuffered CAS-7 Memory Kit HP 3CB (1x2GB) Dual Rank x4 PC3L-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 4GB (1x4GB) Dual Rank x4 PC3L-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 4GB (1x4GB)		HP BL490c G7 Intel® Xeon® X5675 (3.06GHz/6-core/12MB/95W) Processor Kit	637437-B21
HP BL490c G7 Intel® Xeon® E5649 (2.53GHz/6-core/12MB/80W) Processor Kit HP BL490c G7 Intel® Xeon® L5640 (2.26GHz/6-core/12MB/80W) Processor Kit HP BL490c G7 Intel® Xeon® X5672 (3.20GHz/6-core/12MB/90W) Processor Kit KNOTE: When upgrading or ordering spares for CPU 1, reuse the heatsink that was originally shipped with CPU 1 and ensure sufficient thermal grease is applied. HP Memory Registered DIMMs (RDIMMs) HP 2GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Registered CAS-9 Memory Kit HP 4GB (1x4GB) Single Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 500658-B21 Memory Kit HP 4GB (1x4GB) Single Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 604504-B21 Low Power Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. HP 8GB (1x4GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 604504-B21 Low Power Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. HP 8GB (1x4GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 604506-B21 Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. HP 8GB (1x8GB) Dual Rank x4 PC3L-10600 (DDR3-1333) Registered CAS-9 604506-B21 Low Power Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. HP 16GB (1x16GB) Dual Rank x4 PC3L-10600 (DDR3-1333) Registered CAS-9 604506-B21 Low Power Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. HP 16GB (1x16GB) Quad Rank x4 PC3L-5000 (DDR3-1333) Registered CAS-9 627812-B21 LP Memory Kit HP 16GB (1x16GB) Quad Rank x4 PC3L-5000 (DDR3-1333) Unbuffered CAS-9 627814-B21 LP Memory Kit HP 16GB (1x16GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 500666-B21 Memory Kit HP 16GB (1x16GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 500670-B21 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 500670-B21 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 500670-B21 Memory Kit HP 4GB (1x4GB)		HP BL490c G7 Intel® Xeon® X5670 (2.93GHz/6-core/12MB/95W) Processor Kit	603600-B21
HP BL490c G7 Intel® Xeon® L5640 (2.26GHz/6-core/12MB/60W) Processor Kit Four-Core Processors HP BL490c G7 Intel® Xeon® X5672 (3.20GHz/4-core/12MB/65W) Processor Kit HP BL490c G7 Intel® Xeon® L5630 (2.13GHz/4-core/12MB/65W) Processor Kit NOTE: When upgrading or ordering spares for CPU 1, reuse the heatsink that was originally shipped with CPU 1 and ensure sufficient thermal grease is applied. HP Memory Registered DIMMs (RDIMMs)		HP BL490c G7 Intel® Xeon® X5650 (2.66GHz/6-core/12MB/95W) Processor Kit	603603-B21
Four-Core Processors HP BL490c G7 Intel® Xeon® X5672 (3.20GHz/4-core/12MB/95W) Processor Kit HP BL490c G7 Intel® Xeon® L5630 (2.13GHz/4-core/12MB/940W) Processor Kit NOTE: When upgrading or ordering spares for CPU 1, reuse the heatsink that was originally shipped with CPU 1 and ensure sufficient thermal grease is applied. HP Memory Registered DIMMs (RDIMMs) HP 2GB (1x2GB) Dual Rank x8 PC3-10600 (DDR3-1333) Registered CAS-9 500656-B21 Memory Kit HP 4GB (1x4GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 500658-B21 Memory Kit HP 4GB (1x4GB) Single Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 604504-B21 Low Power Memory Kit HP 4GB (1x4GB) Single Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 604504-B21 Low Power Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. HP 8GB (1x8GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 604506-B21 Memory Kit HP 8GB (1x8GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 604506-B21 Memory Kit HP 16GB (1x16GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 604506-B21 Low Power Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. HP 16GB (1x16GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 604506-B21 LP Memory Kit HP 16GB (1x16GB) Dual Rank x4 PC3-8500 (DDR3-1333) Registered CAS-7 607814-B21 LP Memory Kit HP 16GB (1x16GB) Dual Rank x4 PC3-8500 (DDR3-1066) Registered CAS-7 500666-B21 Memory Kit HP 2GB (1x2GB) Dual Rank x4 PC3-10600 (DDR3-1333) Unbuffered CAS-9 607814-B21 LP Memory Kit HP 2GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 500670-B21 Memory Kit HP 2GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 60678-B21 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 60670-B21 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 60670-B21 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 60670-B21 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3		HP BL490c G7 Intel® Xeon® E5649 (2.53GHz/6-core/12MB/80W) Processor Kit	637441-B21
HP BL490c G7 Intel® Xeon® X5672 (3.20GHz/4-core/12MB/95W) Processor Kit HP BL490c G7 Intel® Xeon® L5630 (2.13GHz/4-core/12MB/40W) Processor Kit NOTE: When upgrading or ordering spares for CPU 1, reuse the heatsink that was originally shipped with CPU 1 and ensure sufficient thermal grease is applied. HP Memory Registered DIMMs (RDIMMs) HP 2GB (1x2GB) Dual Rank x8 PC3-10600 (DDR3-1333) Registered CAS-9 Memory Kit HP 4GB (1x4GB) Single Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 500658-B21 Memory Kit HP 4GB (1x4GB) Single Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 593339-B21 Memory Kit HP 4GB (1x4GB) Single Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 604504-B21 Low Power Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. HP 8GB (1x8GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 604506-B21 Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. HP 8GB (1x8GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 604506-B21 Low Power Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. HP 16GB (1x16GB) Dual Rank x4 PC3L-10600 (DDR3-1333) Registered CAS-9 604506-B21 Low Power Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. HP 16GB (1x16GB) Quad Rank x4 PC3L-8500 (DDR3-1333) Registered CAS-9 627812-B21 LP Memory Kit HP 2GB (1x4GB) Single Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-7 500666-B21 Memory Kit Unbuffered with ECC (UDIMMs) HP 1GB (1x1GB) Single Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 500670-B21 Memory Kit HP 2GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 500670-B21 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 500670-B21 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 500670-B21 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 500670-B21 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS		HP BL490c G7 Intel® Xeon® L5640 (2.26GHz/6-core/12MB/60W) Processor Kit	612892-B21
## BL490c G7 Intel® Xeon® L5630 (2.13GHz/4-core/12MB/40W) Processor Kit NOTE: When upgrading or ordering spares for CPU 1, reuse the heatsink that was originally shipped with CPU 1 and ensure sufficient thermal grease is applied. ### P 4GB (1x2GB) Dual Rank x8 PC3-10600 (DDR3-1333) Registered CAS-9 500658-B21 Memory Kit HP 4GB (1x4GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 500658-B21 Memory Kit HP 4GB (1x4GB) Single Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 593339-B21 Memory Kit HP 4GB (1x4GB) Single Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 593339-B21 Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. #### HP 8GB (1x8GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 604504-B21 Low Power Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. #### HP 8GB (1x8GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 604506-B21 Low Power Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. #### HP 8GB (1x8GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 604506-B21 Low Power Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. #### HP 16GB (1x16GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 627812-B21 LP Memory Kit HP 16GB (1x16GB) Quad Rank x4 PC3-10600 (DDR3-1333) Registered CAS-7 500666-B21 Memory Kit HP 2GB (1x2GB) Dual Rank x4 PC3-8500 (DDR3-1066) Registered CAS-7 500668-B21 Memory Kit HP 2GB (1x2GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 500670-B21 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 500670-B21 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 500670-B21 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 500670-B21 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 500670-B21 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 500670-B21 Memory Kit		Four-Core Processors	
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Low Power Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors. HP 16GB (1x16GB) Dual Rank x4 PC3L-10600 (DDR3-1333) Registered CAS-9 LP Memory Kit HP 16GB (1x16GB) Quad Rank x4 PC3-8500 (DDR3-1066) Registered CAS-7 Memory Kit HP 32GB (1x32GB) Quad Rank x4 PC3L-8500 (DDR3-1066) Registered CAS-7 LP Memory Kit Unbuffered with ECC (UDIMMs) HP 1GB (1x1GB) Single Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 2GB (1x2GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit NOTE: All DDR3 memory option kits consist of one DIMM per kit. For detailed memory configuration rules and guidelines, please use the Online DDR3 Memory Configuration Tool: www.hp.com/go/ddr3memory-configurator. NOTE: Kits described as LP include Low Power DIMMs. For more information on ProLiant Energy Efficient Features, see: http://h18004.www1.hp.com/products/servers/platforms/energyefficient/		· · · · · · · · · · · · · · · · · · ·	500662-B21
HP 16GB (1x16GB) Dual Rank x4 PC3L-10600 (DDR3-1333) Registered CAS-9 LP Memory Kit HP 16GB (1x16GB) Quad Rank x4 PC3-8500 (DDR3-1066) Registered CAS-7 Memory Kit HP 32GB (1x32GB) Quad Rank x4 PC3L-8500 (DDR3-1066) Registered CAS-7 LP Memory Kit Unbuffered with ECC (UDIMMs) HP 1GB (1x1GB) Single Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 2GB (1x2GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit NOTE: All DDR3 memory option kits consist of one DIMM per kit. For detailed memory configuration rules and guidelines, please use the Online DDR3 Memory Configuration Tool: www.hp.com/go/ddr3memory-configurator. NOTE: Kits described as LP include Low Power DIMMs. For more information on ProLiant Energy Efficient Features, see: http://h18004.www1.hp.com/products/servers/platforms/energyefficient/		Low Power Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series	604506-B21
Memory Kit HP 32GB (1x32GB) Quad Rank x4 PC3L-8500 (DDR3-1066) Registered CAS-7 LP Memory Kit Unbuffered with ECC (UDIMMs) HP 1GB (1x1GB) Single Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 2GB (1x2GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit NOTE: All DDR3 memory option kits consist of one DIMM per kit. For detailed memory configuration rules and guidelines, please use the Online DDR3 Memory Configuration Tool: www.hp.com/go/ddr3memory-configurator. NOTE: Kits described as LP include Low Power DIMMs. For more information on ProLiant Energy Efficient Features, see: http://h18004.www1.hp.com/products/servers/platforms/energyefficient/		HP 16GB (1x16GB) Dual Rank x4 PC3L-10600 (DDR3-1333) Registered CAS-9	627812-B21
HP 32GB (1x32GB) Quad Rank x4 PC3L-8500 (DDR3-1066) Registered CAS-7 LP Memory Kit Unbuffered with ECC (UDIMMs) HP 1GB (1x1GB) Single Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 2GB (1x2GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit NOTE: All DDR3 memory option kits consist of one DIMM per kit. For detailed memory configuration rules and guidelines, please use the Online DDR3 Memory Configuration Tool: www.hp.com/go/ddr3memory-configurator. NOTE: Kits described as LP include Low Power DIMMs. For more information on ProLiant Energy Efficient Features, see: http://h18004.www1.hp.com/products/servers/platforms/energyefficient/		, ,	500666-B21
HP 1GB (1x1GB) Single Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 2GB (1x2GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit NOTE: All DDR3 memory option kits consist of one DIMM per kit. For detailed memory configuration rules and guidelines, please use the Online DDR3 Memory Configuration Tool: www.hp.com/go/ddr3memory-configurator. NOTE: Kits described as LP include Low Power DIMMs. For more information on ProLiant Energy Efficient Features, see: http://h18004.www1.hp.com/products/servers/platforms/energyefficient/		HP 32GB (1x32GB) Quad Rank x4 PC3L-8500 (DDR3-1066) Registered CAS-7	627814-B21
Memory Kit HP 2GB (1x2GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit NOTE: All DDR3 memory option kits consist of one DIMM per kit. For detailed memory configuration rules and guidelines, please use the Online DDR3 Memory Configuration Tool: www.hp.com/go/ddr3memory-configurator. NOTE: Kits described as LP include Low Power DIMMs. For more information on ProLiant Energy Efficient Features, see: http://h18004.www1.hp.com/products/servers/platforms/energyefficient/		Unbuffered with ECC (UDIMMs)	
Memory Kit HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit NOTE: All DDR3 memory option kits consist of one DIMM per kit. For detailed memory configuration rules and guidelines, please use the Online DDR3 Memory Configuration Tool: www.hp.com/go/ddr3memory-configurator. NOTE: Kits described as LP include Low Power DIMMs. For more information on ProLiant Energy Efficient Features, see: http://h18004.www1.hp.com/products/servers/platforms/energyefficient/		HP 1GB (1x1GB) Single Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9	500668-B21
Memory Kit NOTE: All DDR3 memory option kits consist of one DIMM per kit. For detailed memory configuration rules and guidelines, please use the Online DDR3 Memory Configuration Tool: www.hp.com/go/ddr3memory-configurator. NOTE: Kits described as LP include Low Power DIMMs. For more information on ProLiant Energy Efficient Features, see: http://h18004.www1.hp.com/products/servers/platforms/energyefficient/			500670-B21
memory configuration rules and guidelines, please use the Online DDR3 Memory Configuration Tool: www.hp.com/go/ddr3memory-configurator. NOTE: Kits described as LP include Low Power DIMMs. For more information on ProLiant Energy Efficient Features, see: http://h18004.www1.hp.com/products/servers/platforms/energyefficient/			500672-B21
on ProLiant Energy Efficient Features, see: http://h18004.www1.hp.com/products/servers/platforms/energyefficient/		NOTE: All DDR3 memory option kits consist of one DIMM per kit. For detailed memory configuration rules and guidelines, please use the Online DDR3	
		on ProLiant Energy Efficient Features, see:	



Core Options

HP Hard Drives

NOTE: Hard drives have either a one year or three year warranty; refer to the specific hard drive QuickSpecs for details.

SATA Non-hot Plug 2.5" Enterprise Mainstream Solid State Drives

HP 400GB 3G SATA MLC SFF (2.5-inch) Non-hot plug Enterprise Mainstream 636605-B21 3yr Wty Solid State Drive

HP 200GB 3G SATA MLC SFF (2.5-inch) Non-hot plug Enterprise Mainstream 636601-B21 3yr Wty Solid State Drive

HP 100GB 3G SATA MLC SFF (2.5-inch) Non-hot plug Enterprise Mainstream 3yr Wty Solid State Drive

NOTE: Please see the QuickSpecs for Technical Specifications and additional information:

http://h18000.www1.hp.com/products/quickspecs/14038_div/14038_div.html (Worldwide)



636599-B21

Additional Options

HP Insight software

HP Insight Control

Updates

HP iLO Advanced Blade Electronic License with 3yr 24x7 Tech Support and BD503AAE Updates

HP iLO Advanced Blade 1 Server License with 3yr 24x7 Tech Support and

BD502A

HP Insight Control including 1yr 24x7 Technical Support and Updates Electronic

T9074BAE

License

HP Insight Control including 1yr 24x7 Technical Support and Updates Single Server License

452148-B22

HP Insight Management Media Kit

436222-B21

NOTE: HP Insight Management Media Kit contains DVDs without licenses. Contains HP Systems Insight Manager, HP Insight Control, HP Matrix Operating Environment, and Virtual Connect Enterprise Manager software. Uses an integrated installer to perform quick and accurate software installation and updates.

NOTE: Licenses ship without media. The HP Insight Control Media Kit can be ordered separately, or can be downloaded at:

http://www.hp.com/go/insightupdates.

NOTE: Electronic licenses can be used to purchase multiple licenses with a single activation key, and is available in all countries except China and Japan. Customers in China and Japan should order the physical equivalent.

NOTE: Customer will receive a license entitlement certificate, which must be redeemed online or via fax in order to obtain the license activation key(s). Includes one year of 24 x 7 HP Software Technical Support & Update Service.

NOTE: For additional license kits, including bundles with HP BladeSystem enclosures, please see the Insight Control QuickSpecs at: http://h18004.www1.hp.com/products/quickspecs/12631_div/12631_div.html

(Worldwide)

HP Insight Control for Linux

HP Insight Control for Linux including 1yr 24x7 Support Electronic License HP Insight Control for Linux including 1yr 24x7 Support Single Server License HP Insight Control for Linux Media Kit TC213AAE TC209A TC208A

NOTE: Licenses ship without media. The Media Kit for Insight Control for Linux can be ordered separately, or can be downloaded at: http://www.hp.com/go/iclinux (click on Download button).

NOTE: Electronic licenses can be used to purchase multiple licenses with a single activation key, and are available in all countries except China and Japan. Customers in China and Japan should order the physical equivalent.

NOTE: Customer will receive a license entitlement certificate, which must be redeemed online or via fax in order to obtain the license activation key(s). Includes one year of 24 x 7 HP Software Technical Support Service.

NOTE: For additional License Kits, including electronic licensing options, please see the QuickSpecs at:

http://h18000.www1.hp.com/products/quickspecs/13019_div/13019_div.html (Worldwide)

HP Integrated Lights-Out (iLO) Advanced for BladeSystem

HP iLO Advanced for BladeSystem including 1yr 24x7 Support Electronic License

TA851AAE

HP iLO Advanced for BladeSystem including 1yr 24x7 Support Single Server License

512488-B21

NOTE: Licenses ship without media. The Media Kit for Insight Control for Linux can be ordered separately, or can be downloaded at: http://www.hp.com/go/insightupdates.



Additional Options

NOTE: Electronic licenses can be used to purchase multiple licenses with a single activation key, and is available in all countries except China and Japan. Customers in China and Japan should order the physical equivalent.

NOTE: Customer will receive a license entitlement certificate, which must be redeemed online or via fax in order to obtain the license activation key(s). Includes one year of 24 x 7 HP Software Technical Support Service

NOTE: For additional license kits please see the HP Integrated Lights-Out QuickSpecs at:

http://h18000.www1.hp.com/products/quickspecs/12362_div/12362_div.html (Worldwide)

HP Insight Control server deployment

HP Insight Control Server Deployment including 1yr 24x7 Support Electronic License

T9082AAE

HP Insight Control Server Deployment including 1yr 24x7 Support Single Server License

452151-B21

NOTE: Licenses ship without media. The Insight Control Media Kit can be ordered separately, or can be downloaded at: http://www.hp.com/go/insightupdates.

NOTE: Electronic licenses can be used to purchase multiple licenses with a single activation key, and is available in all countries except China and Japan. Customers in China and Japan should order the physical equivalent.

NOTE: Customer will receive a license entitlement certificate, which must be redeemed online or via fax in order to obtain the license activation key(s). Includes one year of 24 x 7 HP Software Technical Support Service.

NOTE: For additional license kits please see the Insight Control QuickSpecs at: http://h18004.www1.hp.com/products/quickspecs/12631_div/12631_div.html (Worldwide)

High Performance Clusters

HP Cluster Management Utility

HP Cluster Management Utility Flexible License

QL803B

NOTE: This part number can be used to purchase one certificate for multiple licenses with a single activation key. Each license is for one node (server). Customer will receive a printed end user license agreement and license entitlement certificate via physical shipment. The license entitlement certificate must be redeemed online in order to obtain a license key.

HP Insight Cluster Management Utility Flexible License with 3 years of 24x7 updates and technical support

BD476A

NOTE: These part numbers can be used to purchase one certificate for multiple licenses and support with a single activation key. Each license is for one node (server). Customer will receive a printed end user license agreement and license entitlement certificate via physical shipment. The license entitlement certificate must be redeemed online in order to obtain a license key. Customer also will receive a support agreement.

HP Cluster Management Utility Media

BD477A

NOTE: Order a minimum of one license per cluster to purchase media including software and documentation, which will be delivered to the customer, and also licenses CMU management. No license key is delivered or required.

NOTE: For additional license kits please see the QuickSpecs at: http://h18004.www1.hp.com/products/quickspecs/12612_div/12612_div.html (Worldwide)

HP HPC Linux Value Pack

HP High Performance Computing Linux Value Pack 1 Processor Flexible License

TC293B

NOTE: This part number can be used to purchase one certificate for multiple



Additional Options

licenses with a single activation key. Each license is for one socket (a.k.a. processor). Customer will receive a printed end user license agreement and license entitlement certificate via physical shipment. The license entitlement certificate must be redeemed online in order to obtain a license key.

HP High Performance Computing Linux Value Pack Media Kit

NOTE: For additional license kits please see the QuickSpecs at:

NOTE: This part number can be used to purchase media including software and

documentation, which will be delivered to the customer.

http://h18004.www1.hp.com/products/guickspecs/13485_div/13485_div.html

(Worldwide)

HP Security

HP Trusted Platform Module Option

NOTE: The TPM (Trusted Platform Module) is a microcontroller chip that can securely store artifacts used to authenticate the server platform. These artifacts can include passwords, certificates and encryption keys. Windows® BitLocker™ Drive Encryption (BitLocker) is a data protection feature available in Windows Server® 2008. BitLocker leverages the enhanced security capabilities of a Trusted Platform Module (TPM) version 1.2. The TPM works with BitLocker to help protect user data and to ensure that a server running Windows Server 2008

has not been tampered with while the system was offline.

NOTE: For more information about TPM, including a white paper, go to:

http://www.hp.com/go/TPM

NOTE: ProLiant OS pre-installed units will come with the partition required for

TPM deployment.

NOTE: The TPM key is unique to every TPM deployed server and must be

retained. Misplacing or losing the key could result in data loss.

HP Storage Controller HP Smart Array P700m Controller

HP Smart Array P700m/512 4-ports Ext PCle x8 SAS Controller 508226-B21

HP Smart Array P711m Controller

HP Smart Array P711m/1G 6Gb FBWC 4-ports Ext Mezzanine SAS Controller 513778-B21

NOTE: The P711m 1GB cache adds RAID 1+0 and 5.

HP Smart Array P712m Controller

HP Smart Array P712m/256 6Gb 2-ports Int/2-ports Ext Mezzanine SAS 488348-B21

Controller

HP Smart Array P712m/ZM 2-ports Int PCIe x8 SAS Controller 484299-B21

NOTE: Provides RAID support on internal non-hot plug SSDs.

Optional Upgrades

HP Smart Array P-Series Low Profile Battery 452348-B21

NOTE: Supports HP Smart Array P700m Controller.

HP 650 mAh P-series Low Profile Battery

NOTE: Supports HP Smart Array P712m Controller.

HP 256MB P-series Cache Upgrade **NOTE:** Supports HP Smart Array P712m Controller.

HP Smart Array Advanced Pack including 1yr 24x7 Technical Support and

Updates Single Server License

NOTE: A license key, a minimum of 256MB cache, and battery kit is required to

enable Smart Array Advanced Pack features. For more information go to:

http://www.hp.com/go/saap

NOTE: Please see the QuickSpecs for Technical Specifications and additional

http://h18000.www1.hp.com/products/quickspecs/13175 div/13175 div.html



575031-B21

462968-B21

516471-B21

TC294A

488069-B21

Additional Options

(P700m)

http://h18000.www1.hp.com/products/quickspecs/14035_div/14035_div.html

(P711m)

http://h18000.www1.hp.com/products/guickspecs/13296 div/13296 div.html

(P712m)

http://h18000.www1.hp.com/products/guickspecs/13200 div/13200 div.html

(Smart Array Advanced Pack)

HP I/O Expansion Options

HP 640GB IO Accelerator for BladeSystem c-Class HP 320GB IO Accelerator for BladeSystem c-Class **BK836A** AJ878B

NOTE: Please see the QuickSpecs for Technical Specifications and additional

information:

http://h18000.www1.hp.com/products/guickspecs/13220 div/13220 div.html

(Worldwide)

Options

HP c-Class Mezzanine HP 4X QDR QLogic InfiniBand Dual Port Mezzanine HCA for c-Class

583210-B21

592519-B21

BladeSystem

HP 4X QDR InfiniBand ConnectX-2 Dual Port Mezzanine HCA for c-Class

BladeSystem

NOTE: Please see the QuickSpecs for Technical Specifications and additional

information:

http://h18000.www1.hp.com/products/quickspecs/12586_div/12586_div.html

(Worldwide)

HP Ultrium Tape Blades

HP LTO-4 SB1760c Tape Blade

AQ697A

NOTE: LTO-4 Ultrium tape technology.

NOTE: Please see the QuickSpecs for Technical Specifications and additional

information:

http://h18000.www1.hp.com/products/guickspecs/12729 div/12729 div.html

(Worldwide)

HP Storage Blades

HP LTO-5 SB3000c Tape Blade

BS580A

NOTE: Please see the QuickSpecs for Technical Specifications and additional

information:

http://h18000.www1.hp.com/products/guickspecs/12729 div/12729 div.html

(Worldwide)

HP D2200sb Storage Blade

AP880A

NOTE: The HP PCI Express Mezzanine Pass-Thru Card (P/N 431643-B21) is required to support the HP D2200sb PCIe Storage Blade with the BL620c G7. Up to two storage blades are supported per server mix and match (Ultrium Tape,

D2200sb PCIe Storage, and/or PCI Expansion Blades).

NOTE: The HP PCI Express Mezzanine Pass-Thru Card can be placed in

mezzanine slot 2 and/or 3.

NOTE: Please see the HP D2200sb PCIe Storage Blade QuickSpecs for

technical specifications and additional information at:

http://h18006.www1.hp.com/storage/bladesystem/index.html.



HP ProLiant BL490c Generation 7 (G7) Server Blade

Additional Options

HP Expansion Blade

HP BLc PCI Expansion Blade

448018-B21

NOTE: Ships with one pre-installed PCI-X connect board. Also includes one

PCIe connect board which requires installation.

NOTE: Please see the QuickSpecs for Technical Specifications and additional

configuration information:

http://h18000.www1.hp.com/products/guickspecs/12753 div/12753 div.html

(Worldwide)

HP USB and SD Options

HP USB 2-Button Optical Scroll Mouse

DC172B

HP USB Standard Keyboard

DT528A#ABA

HP 2GB USB Flash Media Drive Key Kit

608447-B21

NOTE: HP qualified blank USB key for use with HP ProLiant servers that support the VMware virtualization environment and other HP value-add software like SmartStart. HP recommends this industry standard USB flash device for use with VMware ESXi. USB device must be installed in the internal slot of the ProLiant server for use with VMware ESXi. Refer to HP VMware Getting Started

Guide for installation instructions.

580387-B21

NOTE: Blank SD media devices are supported for use with VMware and Citrix. SD media must be installed in the internal slot of the ProLiant server. Learn

more at: http://www.hp.com/go/proliantvirtualization

HP 4GB Secure Digital High Capacity Flash Media Kit

HP Care Pack Services NOTE: The HP Care Pack service part numbers below for ProLiant BL c-Class server blades, cover the server blade and all HP branded hardware options qualified for the server, purchased at the same time or afterwards, internal to the server.

Hardware Services On-site Service

HP 3 year 4 hour 13x5 BL4xxc Server Blade Hardware Support UK065E HP 3 year 4 hour 24x7 BL4xxc Server Blade Hardware Support UK066E HP 3 year 6 hour 24x7 Call to Repair BL4xxc Server Blade Hardware Support **UK067E**



Memory

NOTE: Memory configurations listed do not apply to "Factory Integrated Models".

Memory Population Guidelines

For detailed memory configuration rules and guidelines, please use the Online DDR3 Memory Configuration Tool: www.hp.com/go/ddr3memory-configurator

Some DIMM installation guidelines are summarized below;

- For the BL490c G7 server with eighteen (18) memory slots:
 - O There are three (3) channels per processor; six (6) channels per server
 - O There are three (3) DIMM slots for each memory channel; eighteen (18) total slots
 - O Memory channel 1 consists of the three (3) DIMMs that are closest to the processor
 - O Memory channel 3 consists of the three (3) DIMMs that are furthest from the processor
- DIMM slots that are white should be populated first
- Do not mix Unbuffered memory (UDIMMs) with Registered memory (RDIMMs)
- Do not install DIMMs if the corresponding processor is not installed
- If only one processor is installed in a 2CPU system, only half of the DIMM slots are available
- To maximize performance, balance the total memory capacity between all installed processors
- It is not required, but it is recommended to load the channels similarly if possible
- If any Quad rank DIMMs are installed, all channels are limited to only 2 DIMMs per channel
- You can only install two quad-rank DIMMs per channel
- You can only install two UDIMMs per channel; the third slot in the channel must remain empty
- Populate DIMMs from heaviest load (quad-rank) to lightest load (single-rank) within a channel
- Heaviest load (DIMM with most ranks) within a channel goes furthest from the processor
- For memory mirroring mode, channel 3 must be unpopulated. Channels 1 and 2 are populated identically
- For lock-step mode, channel 3 must be unpopulated. DIMMs in channels 1 and 2 will be installed in pairs. The paired slots will be 1,4; 2,5; 3;6 on a 3DPC system or 1,4; 2,5; on a 2DPC system
- Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors.
- If mixing DIMM voltage is a requirement, please note that the DIMMs will run at 1.5V since all 1.35V are capable of supporting 1.5V operations

DIMM slot/capaci	DIMM slot/capacity/populated speed table											
DIMM Type	Unbuffered with ECC Registered DIMMS (RDIMMs) DIMMs (UDIMMs)											
DIMM Rank	Single Rank (1R)		Dua	al Rank ((2R)		Qua			Single Rank (1R)		ank (2R)
DIMM Capacity	4GB	2GB	4GB	8GB	8GB	16GB	4GB	16GB	32GB	1GB	2GB	4GB
DIMM Native Speed (MHz)	1333	1333	1333	1066	1333	1333	1066	1066	1066	1333	1333	1333
DIMM Voltage	LV/Std	Std	Std	Std	LV/Std	LV	Std	Std	LV	Std	Std	Std
SLOTS THAT CAN	I BE POF	PULATE	D									
18 slot servers	18	18	18	18	18	18	12	12	12	12	12	12
MAXIMUM CAPAC	ITY (GB)										
	72	36	72	144	144	288	48	192	384	12	24	48
POPULATED DIM	M SPEED) (MHz)										
1 DIMM Per Channel	1333	1333	1333	1066	1333	1333	1066	1066	1066	1333	1333	1333
2 DIMM Per Channel	1333	1333	1333	1066	1333	1333	800	800	800	1066	1066	1066
3 DIMM Per Channel	800	800	800	800	800	800	n/a	n/a	n/a	n/a	n/a	n/a



Memory

NOTES:

- PC3-10600 DIMMs have a maximum speed of 1333MHz. PC3-8500 DIMMs have a maximum speed of 1066MHz
- Mixing DIMM speeds is allowed, but the system processor speed rules always override the DIMM capabilities
- If you do mix DIMM speeds, the memory bus will default to the minimum clock rate of all DIMMs in the system even if the slower DIMM is on the other processor
- If you install 1x 1066MHz DIMM in channel 1 and 1x 1333MHz DIMM in channel 2, the maximum speed will be 1066MHz
- If you install 1x 1066MHz DIMM in channel 1 and 5x 1333MHz DIMMs with 1 DIMM Per Channel (DPC) in each of the other channels, the maximum speed will be 1066MHz
- If you install 3DPC in one channel (if applicable) and 1DPC in all other channels, you run at 800MHz
- Maximum memory speed will also depend on the processor installed
- References to the above MHz speeds are for the various speeds of DDR3 DIMMs; 1333 refers to DDR3-1333, etc

HP ProLiant BL490c G7 Server Blade DIMM slot and configuration diagrams Basic memory slot & population diagram

• Population order; start with "A" first, "B" second, "C" third, etc.

		18 DIMM SLOTS	(9 per CPU node)		
	CI	PU1	CF	U2	
	slot#	population order	slot#	population order	
Chnl 1	1	G	1	G	Chnl 1
	2	D	2	D	
	3	Α	3	Α	
Chnl 2	4	Н	4	Н	Chnl 2
	5	E	5	E	1
	6	В	6	В]
Chnl 3	7	I	7	I	Chnl 3
	8	F	8	F]
	9	С	9	С	1

HP ProLiant BL490c G7 Server Blade (1P Model) Standard memory configuration (1 CPU model)

• 6GB (3 x 2GB) of PC3-10600 (DDR3-1333) RDIMMs

	CPU1		CPU2		
	slot#	population order	slot#	population order	
Chnl 1	1	G: empty	1	G: empty	Chnl 1
	2	D: empty	2	D: empty	
	3	A: 2GB DIMM	3	A: empty	
Chnl 2	4	H: empty	4	H: empty	Chnl 2
	5	E: empty	5	E: empty	
	6	B: 2GB DIMM	6	B: empty	
Chnl 3	7	I: empty	7	I: empty	Chnl 3
	8	F: empty	8	F: empty	
	9	C: 2GB DIMM	9	C: empty]



Memory

Standard memory plus optional memory (1 CPU model)

- 54GB, consisting of three (3) 2GB RDIMMs plus six (6) 8GB RDIMMs
 - O 3x 2GB dual-rank PC3-10600 RDIMMs
 - O 6x 8GB dual-rank PC3-8500 RDIMMs

	CPU1		CPU2		
	slot#	population order	slot#	population order	
Chnl 1	1	G: 8GB DIMM	1	G: empty	Chnl 1
	2	D: 8GB DIMM	2	D: empty	
	3	A: 2GB DIMM	3	A: empty	
Chnl 2	4	H: 8GB DIMM	4	H: empty	Chnl 2
	5	E: 8GB DIMM	5	E: empty	
	6	B: 2GB DIMM	6	B: empty	
Chnl 3	7	I: 8GB DIMM	7	I: empty	Chnl 3
	8	F: 8GB DIMM	8	F: empty	
	9	C: 2GB DIMM	9	C: empty]

Standard Memory Replaced with Optional Memory (1 CPU model) RDIMM maximum configuration

• 96GB, consisting of nine (9) 16GB quad-rank PC3-8500 RDIMMs

	С	CPU1		CPU2	
	slot#	population order	slot#	population order	
Chnl 1	1	G: empty	1	G: empty	Chnl 1
	2	D: 16GB DIMM	2	D: empty]
	3	A: 16GB DIMM	3	A: empty	<u> </u>
Chnl 2	4	H: empty	4	H: empty	Chnl 2
	5	E: 16GB DIMM	5	E: empty	
	6	B: 16GB DIMM	6	B: empty	
Chnl 3	7	I: empty	7	I: empty	Chnl 3
	8	F: 16GB DIMM	8	F: empty]
	9	C: 16GB DIMM	9	C: empty]

UDIMM maximum configuration (1 CPU model)

• 24GB, consisting of six (6) 4GB dual-rank PC3-10600 UDIMMs



Memory

	CPU1		CPU2		
	slot#	population order	slot#	population order	
Chnl 1	1	G: empty	1	G: empty	Chnl 1
	2	D: 4GB DIMM	2	D: empty	
	3	A: 4GB DIMM	3	A: empty]
Chnl 2	4	H: empty	4	H: empty	Chnl 2
	5	E: 4GB DIMM	5	E: empty	
	6	B: 4GB DIMM	6	B: empty	ļ
Chnl 3	7	I: empty	7	I: empty	Chnl 3
	8	F: 4GB DIMM	8	F: empty	
	9	C: 4GB DIMM	9	C: empty	

Standard Memory Replaced with Optional Memory (2 CPU Model) RDIMM maximum configuration

• 384GB, consisting of twelve (18) 32GB quad-rank PC3L-8500 RDIMMs

	С	CPU1		CPU2	
	slot#	population order	slot#	population order	
Chnl 1	1	G: empty	1	G: empty	Chnl 1
	2	D: 32GB DIMM	2	D: 32GB DIMM	
	3	A: 32GB DIMM	3	A: 32GB DIMM]
Chnl 2	4	H: empty	4	H: empty	Chnl 2
	5	E: 32GB DIMM	5	E: 32GB DIMM	
	6	B: 32GB DIMM	6	B: 32GB DIMM	
Chnl 3	7	I: empty	7	I: empty	Chnl 3
	8	F: 32GB DIMM	8	F: 32GB DIMM]
	9	C: 32GB DIMM	9	C: 32GB DIMM]

UDIMM maximum configuration (2 CPU model)

• 48GB, consisting of twelve (12) 4GB dual-rank PC3-10600 UDIMMs

	CPU1		CPU2		
	slot#	population order	slot#	population order	
Chnl 1	1	G: empty	1	G: empty	Chnl 1
	2	D: 4GB DIMM	2	D: 4GB DIMM]
	3	A: 4GB DIMM	3	A: 4GB DIMM	
Chnl 2	4	H: empty	4	H: empty	Chnl 2
	5	E: 4GB DIMM	5	E: 4GB DIMM	
	6	B: 4GB DIMM	6	B: 4GB DIMM	
Chnl 3	7	I: empty	7	I: empty	Chnl 3
	8	F: 4GB DIMM	8	F: 4GB DIMM]
	9	C: 4GB DIMM	9	C: 4GB DIMM]

NOTE: Capacity references are rounded to the common Gigabyte values.



Memory

- 1GB = 1024MB
- 2GB = 2048MB
- 4GB = 4096MB
- 8GB = 8192MB
- 16GB = 16384MB
- 32GB = 32768MB

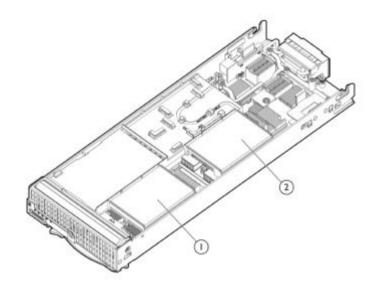
Following are mem	ory options available from HP:	
HP Memory	Registered DIMMs (RDIMMs)	
	HP 2GB (1x2GB) Dual Rank x8 PC3-10600 (DDR3-1333) Registered CAS-9 Memory Kit	500656-B21
	HP 4GB (1x4GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 Memory Kit	500658-B21
	HP 4GB (1x4GB) Single Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 Memory Kit	593339-B21
	HP 4GB (1x4GB) Single Rank x4 PC3L-10600 (DDR3-1333) Registered CAS-9 Low Power Memory Kit	604504-B21
	NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors.	
	HP 8GB (1x8GB) Dual Rank x4 PC3-10600 (DDR3-1333) Registered CAS-9 Memory Kit	500662-B21
	HP 8GB (1x8GB) Dual Rank x4 PC3L-10600 (DDR3-1333) Registered CAS-9 Low Power Memory Kit NOTE: Low Voltage DIMMs can only be used with Intel Xeon 5600 series processors.	604506-B21
	HP 16GB (1x16GB) Dual Rank x4 PC3L-10600 (DDR3-1333) Registered CAS-9 LP Memory Kit	627812-B21
	HP 16GB (1x16GB) Quad Rank x4 PC3-8500 (DDR3-1066) Registered CAS-7 Memory Kit	500666-B21
	HP 32GB (1x32GB) Quad Rank x4 PC3L-8500 (DDR3-1066) Registered CAS-7 LP Memory Kit	627814-B21
	Unbuffered with ECC (UDIMMs)	
	HP 1GB (1x1GB) Single Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit	500668-B21
	HP 2GB (1x2GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit	500670-B21
	HP 4GB (1x4GB) Dual Rank x8 PC3-10600 (DDR3-1333) Unbuffered CAS-9 Memory Kit	500672-B21
	NOTE: All DDR3 memory option kits consist of one DIMM per kit. For detailed	

memory configuration rules and guidelines, please use the Online DDR3 Memory Configuration Tool: www.hp.com/go/ddr3memory-configurator.

NOTE: PC3L is a low voltage memory.



Storage



1 Non Hot Plug Solid State Drive (SSD) Bay 1

2 Non Hot Plug Solid State Drive (SSD) Bay 2

Hard Drives

NOTE: Hard drives have either a one year or three year warranty; refer to the specific hard drive QuickSpecs for details.

SATA Non-hot Plug 2.5" Midline (MDL) Solid State Drives

	Quantity Supported	Position Supported	Controller
400GB 3G SATA MLC SSF SSD	2	1-2	HP Integrated SATA Controller HP Smart Array P712m Controller
200GB 3G SATA MLC SSF SSD			
100GB 3G SATA MLC			
SSF SSD			



Technical Specifications

System Unit Dimensions (H x W x D) 7.154 x 2.19 x 20.058 in (18.17 x 5.56 x 50.95 cm)

(with bezel)

Weight Maximum 14.20 lb (6.44 kg)

(approximate) (all hard drives and

processors installed)

Minimum 10.75 lb (4.87 kg)

(one hard drive and processor installed)

Power Specifications For power specifications including Input Requirements, BTU Rating, and

Power Supply Output, please see the HP BladeSystem c-Class

Enclosures QuickSpecs located at URL:

HP BladeSystem c3000 Enclosure QuickSpecs:

http://h18000.www1.hp.com/products/quickspecs/12790_div/

12790_div.html

HP BladeSystem c7000 Enclosure QuickSpecs:

http://h18000.www1.hp.com/products/quickspecs/12810 div/

12810_div.html

To review typical system power ratings use the HP BladeSystem Power

Sizer which is available via the online tool located at URL: http://www.hp.com/go/bladesystem/powercalculator

Tittp://www.fip.com/go/bladesystem/powerealediator

NOTE: For optimal cooling and system performance the BL490c G7 requires the c7000 enclosure to be configured with 10 fans and the

c3000 enclosure to be configured with 6 fans.

System Inlet Temperature Operating 10° to 35°C (50° to 95°F) at sea level with an

altitude derating of 1.0°C per every 305 m (1.8°F per every 1000 ft) above sea level to a maximum of 3050 m (10,000 ft), no direct sustained sunlight. Maximum rate of change is 10°C/hr (18°F/hr). The upper limit may be limited by the type and number of options

installed.

System performance may be reduced if operating with a fan fault or above 30°C

(86°F).

Non-operating -30° to 60°C (-22° to 140°F). Maximum rate of

change is 20°C/hr (36°F/hr).

Relative Humidity

(non-condensing)

Operating 10 to 90% relative humidity (Rh), 28°C

(82.4°F) maximum wet bulb temperature, non-

condensing.

Non-operating 5 to 95% relative humidity (Rh), 38.7°C

(101.7°F) maximum wet bulb temperature,

non-condensing.

Altitude Operating 3050 m (10,000 ft). This value may be limited

by the type and number of options installed.

Maximum allowable altitude change rate is

457 m/min (1500 ft/min).

Non-operating 9144 m (30,000 ft). Maximum allowable

altitude change rate is 457 m/min (1500

ft/min).

Acoustic Noise For acoustic noise specifications, please see the HP BladeSystem c-

Class Enclosures QuickSpecs located at URL:



Technical Specifications

HP BladeSystem c3000 Enclosure QuickSpecs:

http://h18000.www1.hp.com/products/quickspecs/12790_div/

12790 div.html

HP BladeSystem c7000 Enclosure QuickSpecs:

http://h18000.www1.hp.com/products/quickspecs/12810 div/

12810 div.html

HP Integrated Lights-Out 3 (iLO 3)

integrated on system board

Architecture Processor Upgradeability PCI Express based health and remote management ASIC PCI Express RISC processor core running at 250MHz Option firmware upgradeable via Flash ROM

Video Support 1600 x 1200 DVR max resolution

Interfaces One Ethernet network connection (10/100Mb/s) 128-MB DDR with ECC

Memory **Operating System** Support

Microsoft Windows 2008 R2

Microsoft Windows 2008 (32 bit and 64 bit)

Microsoft Windows Server 2008 Standard Edition (32bit and 64bit) Microsoft Windows Server 2008 Enterprise Edition (32bit and 64bit)

Red Hat Enterprise Linux 5.4 (32 bit and 64 bit) SUSE LINUX Enterprise Server 11 (32bit and 64bit) SUSE LINUX Enterprise Server 10 (32bit and 64bit)

VMware ESX 4.0 VMware ESX 3.5.0

Client System Support Microsoft Windows 7

Microsoft Windows XP Professional Edition

Microsoft Windows Vista Business and Ultimate Editions

Red Hat Enterprise Desktop 5.00 SUSE Linux Enterprise Desktop 11 SUSE Linux Enterprise Desktop 10

Client Browser Support Microsoft Internet Explorer 8

Microsoft Internet Explorer 7 Microsoft Internet Explorer 6

Firefox 3.5 (on supported Windows and Linux systems) Firefox 3.0 (on supported Windows and Linux systems)

Command Line Support

Secure Shell and serial port access

Secure Socket Layer

Secure Shell version 2 Advanced Encryption Standard (AES) and Triple Data Encryption

Standard (3DES) on browser, CLP and XML scripting interface

AES encryption of video RC4 encryption of video

Directory Support

Services

Security

Active Directory v1.0 (Windows 2003)

Driver Support HP ProLiant iLO3 Management Controller Driver Package Management protocols SNMP, IPMI 2.0 (system and LAN interface), DMTF Systems

supported

Management Architecture for Server Hardware Command Line Protocol

(SMASH CLP), HP RIBCL XML



HP ProLiant BL490c Generation 7 (G7) Server Blade

Technical Specifications

Embedded HP NC553i Type **Dual Port FlexFabric** 10Gb Adapter

Integrated dual-port KR 10GbE with FlexFabric (FCoE or iSCSI)

capability

Network Processor

ServerEngines BE3 x8 PCI Express 2.0

Data Transfer Method

Network Transfer Rate Two ports at 20 Gbps full duplex; 40 Gbps aggregate full duplex

theoretical bandwidth

NOTE: Each port is autosensing 1 Gb / 10 Gb, and can interoperate with 1 Gb HP BladeSystem c-Class interconnect components. Both

ports will operate at the same speed. NOTE: Each port on the NC553i adapter transmits from the server at 20

Gbps (theoretical) full duplex.

IEEE Compliance

802.1p QoS, 802.1Q VLAN tagging, 802.3ad link aggregation, 802.3ap 10GBase-KR. and 802.3x flow control

Standard Features

 ProLiant Teaming including Network Fault Tolerance, Transmit Load Balancing, and Switch-Assisted Load Balancing

• 9K Jumbo frames (4K Jumbo frames when in FCoE mode)

Microsoft Windows Receive Side Scaling (RSS)

Optional accelerated iSCSI

Environment-friendly Products and Approach

End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return, trade-in, and recycling programs in many geographic areas. For trade-in information, please go to: http://www.hp.com/go/green. To recycle your product, please go to: http://www.hp.com/go/green or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/green. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

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For hard drives, 1GB = 1 billion bytes. Actual formatted capacity is less.

